

T591, Tantalum, Polymer Tantalum, 2.2 uF, 20%, 35 VDC, SMD, Polymer, Molded, Low ESR, 150 mOhms, 3528, Height Max = 2.1mm



Dimensions

Footprint	3528
L	3.5mm +/-0.2mm
W	2.8mm +/-0.2mm
H	1.9mm +/-0.2mm
T	0.13mm REF
S	0.8mm +/-0.3mm
F	2.2mm +/-0.1mm
A	1.1mm MIN
B	0.4mm +/-0.15mm
P	0.5mm REF
R	1mm REF
X	0.1mm +/-0.1mm

Packaging Specifications

Weight:	94.85 mg
Packaging:	T&R, 178mm
Packaging Quantity:	2000

General Information

Series:	T591
Dielectric:	Polymer Tantalum
Style:	SMD Chip
Description:	SMD, Polymer, Molded, Low ESR
Features:	Automotive
RoHS:	Yes
Termination:	Tin
Qualifications:	AEC-Q200 (Limited 500 Hrs 85C/85% RH/Ur)
AEC-Q200:	Subject to PPAP/PSW and change control
Shelf Life:	52 Weeks
MSL:	3

Specifications

Capacitance:	2.2 uF
Capacitance Tolerance:	20%
Voltage DC:	35 VDC (105C), 23.45 VDC (125C)
Temperature Range:	-55/+125°C
Rated Temperature:	105°C
Humidity:	85C, 85% RH, load, 500 Hours
Dissipation Factor:	8% 120Hz 25C
Failure Rate:	N/A
Resistance:	150 mOhms (100kHz 25C)
Ripple Current:	950 mA (rms, 100kHz 45C), 665 mA (rms, 105C), 237.5 mA (rms, 125C)
Leakage Current:	7.7 uA (5min 25°C)